

Performance Analysis of Various Modulation Techniques Over 448G Channels

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Introduction

- Higher bandwidth interconnects are needed to continue scaling AI clusters and support nextgeneration AI models.
- The increase in bandwidth can be achieved by either increasing the number of lanes within a given form factor or increasing the speed of each lane.
- This presentation aims to determine performance requirements for 448G channels and interconnect solutions using known channel configurations.
- The study will assess the performance of these channels at 448G using various modulation techniques.
- The results will be compared to highlight potential advantages and limitations of each modulation scheme within the 448G framework.

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 The goal is to forecast the channel requirements that the industry will need to meet to achieve 448G performance. **Typical AI Rack**



Typical Scale Out/Scale Up Topologies



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Interconnect Impairments for 448G data rates

- Separable Mating Interface
 - Cantilever beam lead-in tip stub
 - Gold finger pad stub
 - Lack of full shielding

- PCB Attachment
 - SMT "J" Lead
 - Solder inconsistency
 - SMT pad stub
 - Via transition

Twinax Termination

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 Transition from twinax to PCB pad

Note: Only few impairments are highlighted here



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Analysis Methodology: Idealized Scale-Out Channels

- Two channel topologies, as shown below, are simulated to understand the requirements for 448G data operation
- Channel impairments like Chip BGA attach, Via transition, Connector SMT attachment, twinax termination etc idealized to achieve a smooth Insertion Loss across entire bandwidth
- Bandwidth (i.e. IL resonance frequency) is varied by modifying stub length of mating interface
- Insertion Loss at Nyquist frequencies is varied by adding trace loss.





Analysis Methodology: Idealized Scale-Out Channels

- Co-packaged Copper (CPC) channels allows for longer reach compared to PCB channels for same insertion loss
- Alternatively, CPC channels have lower Insertion Loss for same reach of PCB channels
- Power sum crosstalk (FEXT and NEXT) for both channel topologies is scaled to generate various signal to noise ratios in the analysis









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Baseband pulse amplitude modulation (PAM) basics

Modulation	Dimensions	Bits per dimension	Signaling rate, GBd	Bandwidth, GHz	Distance reduction, dB
PAM-4	1	2	225 (212.5)	112.5 (106.25)	—
PAM-6	2	2.5	180 (170)	90 (85)	-4.44
PAM-8	1	3	150 (142.5)	75 (71.25)	-7.36
$\langle \rangle \rangle \times$					

Selection of modulation options for 450 Gb/s (425 Gb/s)

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Reduce bandwidth requirements

Increase difficulty to detect signals

Performance versus signal-to-noise ratio (SNR)

Denser constellations require better SNR for the same BER performance

Modulation	BER at SNR = 19 dB	Δ	SNR for BER = 2.4e-5	Δ
PAM-4	2.4e-5		19	
PAM-6	3e-3	125x	22.6	+3.6
PAM-8	1.5e-2	625x	25.1	+6.1

- Insertion loss, return loss (reflections), crosstalk, etc. all influence SNR
- This suggests that lower bandwidth channels also need lower reflections and crosstalk
- Improved detection e.g., maximum likelihood sequence detection, and additional error correction can be used to relax SNR requirements

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Translating channel characteristics to link performance

- BER is a function of SNR
- BER target can be translated into a noise power budget
- Map channel characteristics to noise budget terms

Characteristic	Noise power budget term(s) affected		
Insertion loss (IL)	σ_{isi}^2 σ_{next}^2 , σ_{fext}^2 , σ_{rx}^2 (noise enhancement)		
Insertion loss deviation (ILD)	σ_{isi}^2 (reflections) σ_{next}^2 , σ_{fext}^2 , σ_{rx}^2 (roll-off, noise enhancement)		
Return loss (RL)	σ_{isi}^2 (reflections)		
Power-sum near-end crosstalk (PSNEXT)	σ_{next}^2		
Power-sum far-end crosstalk (PSFEXT)	σ_{fext}^2		

 $SNR = 10\log_{10}\left(\frac{\sigma_s^2}{\sigma_n^2}\right)$

= Addressed in this presentation

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Noise power due to insertion loss and roll-off

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- Insertion loss and roll-off contribute to the noise budget through the receiver equalizer
- Equalizer applies gain to counteract the loss of the channel but this same gain boosts internal sources of noise
- Noise may be introduced at multiple points in the signal processing chain
- The same principles apply to the enhancement of crosstalk noise
- For a given channel, PAM-8 requires less equalization but is more sensitive to noise

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Putting it all together

- Add noise terms for comparison to the total budget
- Modulation advantage for one noise term can be offset by a disadvantage for another noise term (or terms)
- Portion of the noise budget must be reserved for terms not included in this analysis e.g., reflections, jitter
- Higher unallocated budget means higher confidence that a working link is achievable
- Roll-off relative to signaling rate has significant influence on the fraction of the noise budget consumed however roll-off frequency just past Nyquist frequency might be sufficient

Summary and conclusions

- Encouraging signs that next-generation channels will be able to support 400G/lane using baseband pulse amplitude modulation
- Channel bandwidth observations
 - PAM-8: Better suited for longer-reach channels with the lowest bandwidth
 - PAM-6: Best reach achieved at highest roll-off frequency (85 GHz)
 - PAM-4: Not considered, roll-offs much lower than the Nyquist frequency (106-112 GHz)
- PAM-8 has the most challenging noise budget
- Generally, smaller constellations are preferred if the channel bandwidth supports it
- Crosstalk must be managed for best performance and resonances at higher frequencies should be avoided

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- Interconnect feasibility
 - PAM-8: Potential to support longer reaches (than alternatives) over existing form factors
 - PAM-6: Benefits from improvement to existing form factors (that may break backwards-compatibility)
 - PAM-4: Requires completely new form factor and technology to meet performance requirements

Thank You

Q&A

